



#### **60V DUAL N-CHANNEL 175°C MOSFET**

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	50mΩ @ V <sub>GS</sub> = 10V	16.7A
60V	65mΩ @ V <sub>GS</sub> = 4.5V	14.6A

### **Features and Benefits**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>G</sub> Minimizes Switching Losses
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

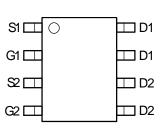
- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.076 grams (Approximate)

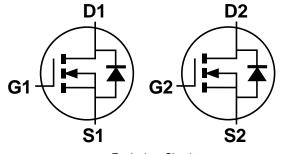






SO-8

Top View Pin Configuration



**Equivalent Circuit** 

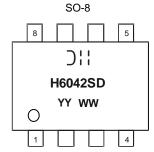
#### **Ordering Information** (Note 5)

Part Number	Case	Packaging
DMNH6042SSDQ-13	SO-8	2.500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



);; = Manufacturer's Marking H6042SD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 16 = 2016) WW = Week (01 - 53)



# **Maximum Ratings** $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	$V_{DSS}$	60	V		
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
Continuous Dusin Courset (Note 7) \	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	5.3 4.4	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	16.7 14	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	35	Α		
Maximum Continuous Body Diode Forward Current (	Is	2.3	Α		
Avalanche Current (Note 8) L = 10mH	I <sub>AS</sub>	3.5	Α		
Avalanche Energy (Note 8) L = 10mH	E <sub>AS</sub>	65	mJ		

### **Thermal Characteristics**

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)		$P_{D}$	1.5	W	
The arrest Decision as It maties to Ambient (Nate C)		D	100	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	61	C/VV	
Total Power Dissipation (Note 7)		$P_D$	2.1	W	
Thermal Resistance, Junction to Ambient (Note 7)  Steady State t<10s		$R_{ heta JA}$	72		
			44	°C/W	
Thermal Resistance, Junction to Case (Note 7)		R <sub>0</sub> JC	7.25		
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +175	°C	

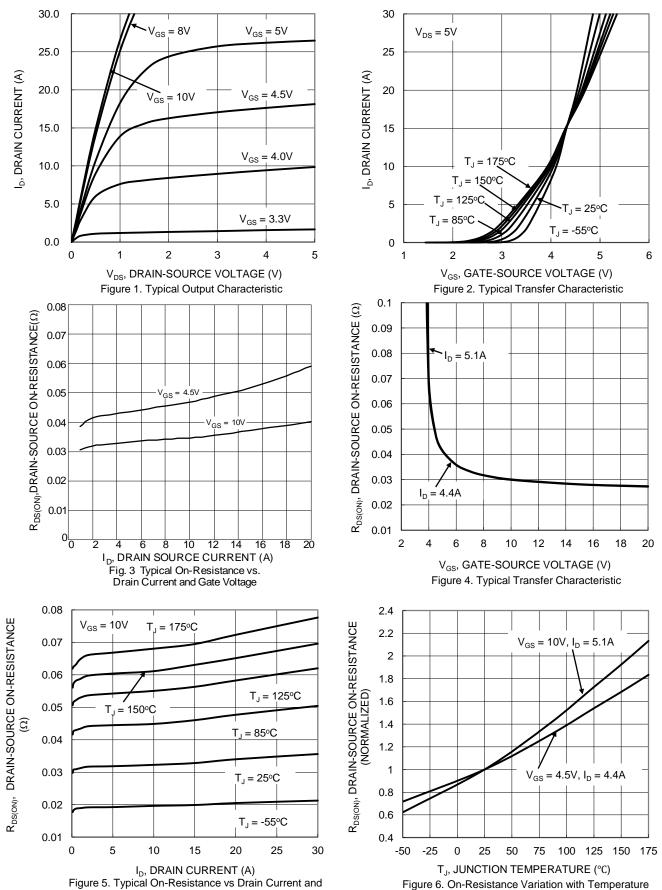
### Electrical Characteristics (@T<sub>A</sub>= +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C		_	_	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	3.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	34	50	mΩ	$V_{GS} = 10V, I_D = 5.1A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	45	65		$V_{GS} = 4.5V, I_D = 4.4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 2.6A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C <sub>ISS</sub>	_	584	_	pF	\/ OF\/ \/ O\/	
Output Capacitance	Coss	_	83	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	24	_	pF		
Gate Resistance	R <sub>G</sub>	_	3.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_G$	_	4.2	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_{G}$	_	8.8	_	nC	140/ 1 504	
Gate-Source Charge	Q <sub>GS</sub>	_	1.8	_	nC	$V_{DS} = 44V, I_{D} = 5.2A$	
Gate-Drain Charge	$Q_{GD}$	_	1.8	_	nC	1	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.4	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	1.9	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_G = 6\Omega, I_D = 1A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	10.1	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	4.5	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	12.9	_	ns	1 2 CA di/dt 100A/:	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	5.4	_	nC	I <sub>F</sub> = 2.6A, di/dt = 100A/μs	

Notes:

- 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 8.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J$  = +25°C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.





Temperature



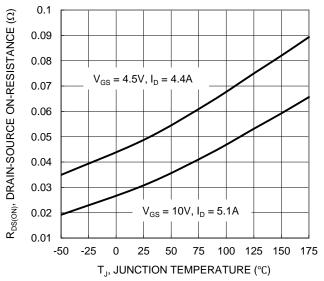
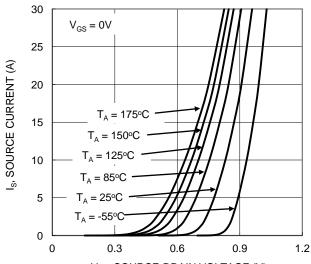


Figure 7. On-Resistance Variation with Temperature



V<sub>SD</sub>, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

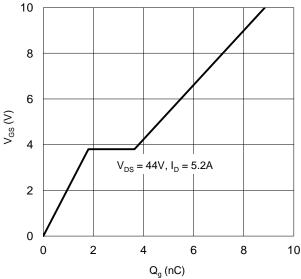


Figure 11. Gate Charge

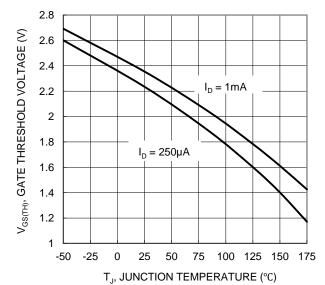


Figure 8. Gate Threshold Variation vs Junction Temperature

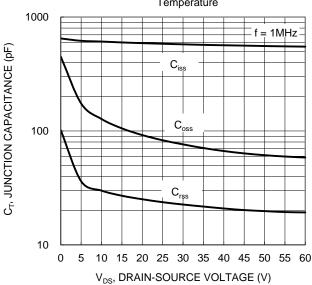
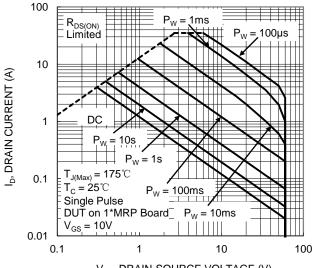


Figure 10. Typical Junction Capacitance



V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



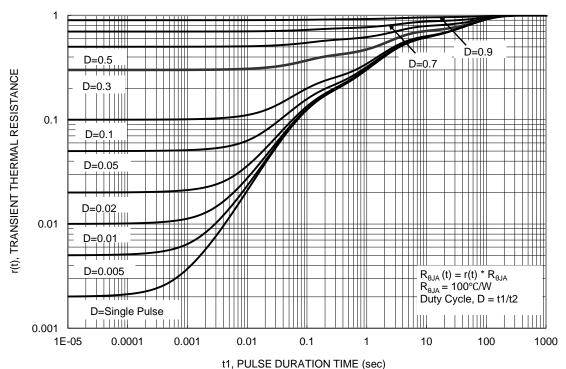


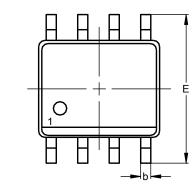
Figure 13. Transient Thermal Resistance

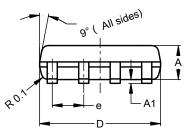


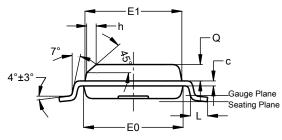
## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

**SO-8** 





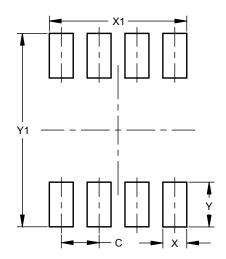


SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е	_	_	1.27			
h	_	_	0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

**SO-8** 



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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